

## Unit Loading/Fan Out

| Pin Names       | Description   | U.L.<br>HIGH/LOW | Input $I_{IH}/I_{IL}$<br>Output $I_{OH}/I_{OL}$ |
|-----------------|---------------|------------------|---|
| $D_0$ – $D_9$   | Data Inputs   | 1.0/1.0          | 20 $\mu$ A/–0.6 mA                              |
| $\overline{OE}$ | Output Enable | 1.0/1.0          | 20 $\mu$ A/–0.6 mA                              |
| CP              | 3-STATE Input | 1.0/1.0          | 20 $\mu$ A/–0.6 mA                              |
| $O_0$ – $O_9$   | Clock Input   | 150/40 (33.3)    | –3.0 mA/24 mA (20 mA)                           |

## Functional Description

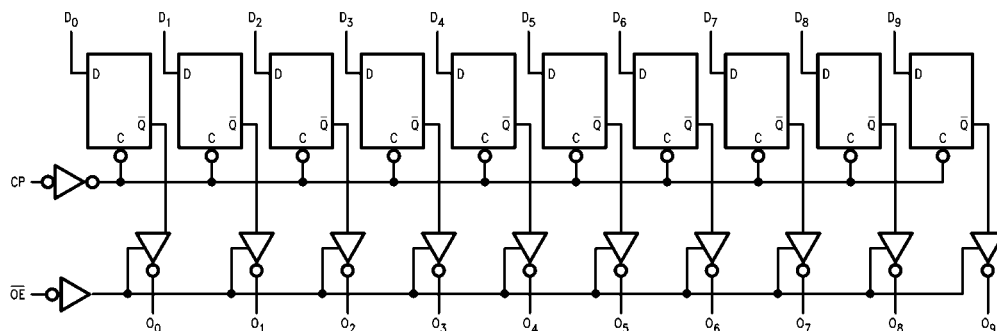
The 74F821 consists of ten D-type edge-triggered flip-flops. This device has 3-STATE true outputs for bus systems organized in a broadside pinning. The buffered Clock (CP) and buffered Output Enable ( $\overline{OE}$ ) are common to all flip-flops. The flip-flops will store the state of their individual D inputs that meet the setup and hold times requirements on the LOW-to-HIGH CP transition. With the  $\overline{OE}$  LOW the content of the flip-flops are available at the outputs. When the  $\overline{OE}$  is HIGH, the outputs go to the high impedance state. Operation of the  $\overline{OE}$  input does not affect the state of the flip-flops.

## Function Table

| Inputs          |            |   | Internal       | Output | Function          |
|-----------------|------------|---|----------------|--------|-------------------|
| $\overline{OE}$ | CP         | D | $\overline{Q}$ | O      |                   |
| H               | H          | X | NC             | Z      | Hold              |
| H               | L          | X | NC             | Z      | Hold              |
| H               | $\nearrow$ | L | H              | Z      | Load              |
| H               | $\nearrow$ | H | L              | Z      | Load              |
| L               | $\nearrow$ | L | H              | L      | Data Available    |
| L               | $\nearrow$ | H | L              | H      | Data Available    |
| L               | H          | X | NC             | NC     | No Change in Data |
| L               | L          | X | NC             | NC     | No Change in Data |

L = LOW Voltage Level  
H = HIGH Voltage Level  
X = Immaterial  
Z = High Impedance  
 $\nearrow$  = LOW-to-HIGH Transition  
NC = No Change

## Logic Diagram



Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

**Absolute Maximum Ratings**(Note 1)

|   |                   |
|---|-------------------|
| Storage Temperature                         | -65°C to +150°C   |
| Ambient Temperature under Bias              | -55°C to +125°C   |
| Junction Temperature under Bias             | -55°C to +150°C   |
| V <sub>CC</sub> Pin Potential to Ground Pin | -0.5V to +7.0V    |
| Input Voltage (Note 2)                      | -0.5V to +7.0V    |
| Input Current (Note 2)                      | -30 mA to +5.0 mA |

Voltage Applied to Output

in HIGH State (with V<sub>CC</sub> = 0V)Standard Output -0.5V to V<sub>CC</sub>

3-STATE Output -0.5V to +5.5V

Current Applied to Output

in LOW State (Max) twice the rated I<sub>OL</sub> (mA)**Recommended Operating Conditions**

|                              |                |
|------------------------------|----------------|
| Free Air Ambient Temperature | 0°C to +70°C   |
| Supply Voltage               | +4.5V to +5.5V |

**Note 1:** Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

**Note 2:** Either voltage limit or current limit is sufficient to protect inputs.

**DC Electrical Characteristics**

| Symbol           | Parameter                         | Min  | Typ                      | Max  | Units | V <sub>CC</sub> | Conditions   |
|------------------|-----------------------------------|--|--------------------------|------|-------|-----------------|--|
| V <sub>IH</sub>  | Input HIGH Voltage                | 2.0  |                          |      | V     |                 | Recognized as a HIGH Signal  |
| V <sub>IL</sub>  | Input LOW Voltage                 |  |                          | 0.8  | V     |                 | Recognized as a LOW Signal   |
| V <sub>CD</sub>  | Input Clamp Diode Voltage         |  |                          | -1.2 | V     | Min             | I <sub>IN</sub> = -18 mA   |
| V <sub>OH</sub>  | Output HIGH Voltage               | 10% V <sub>CC</sub><br>10% V <sub>CC</sub><br>5% V <sub>CC</sub><br>5% V <sub>CC</sub> | 2.5<br>2.4<br>2.7<br>2.7 |      | V     | Min             | I <sub>OH</sub> = -1 mA<br>I <sub>OH</sub> = -3 mA<br>I <sub>OH</sub> = -1 mA<br>I <sub>OH</sub> = -3 mA |
| V <sub>OL</sub>  | Output LOW Voltage                | 10% V <sub>CC</sub>  |                          | 0.5  | V     | Min             | I <sub>OL</sub> = 24 mA  |
| I <sub>IH</sub>  | Input HIGH Current                |  |                          | 5.0  | μA    | Max             | V <sub>IN</sub> = 2.7V   |
| I <sub>BVI</sub> | Input HIGH Current Breakdown Test |  |                          | 7.0  | μA    | Max             | V <sub>IN</sub> = 7.0V   |
| I <sub>CEx</sub> | Output HIGH Leakage Current       |  |                          | 50   | μA    | Max             | V <sub>OUT</sub> = V <sub>CC</sub>   |
| V <sub>ID</sub>  | Input Leakage Test                | 4.75   |                          |      | V     | 0.0             | I <sub>ID</sub> = 1.9 μA,<br>All Other Pins Grounded   |
| I <sub>OD</sub>  | Output Leakage Circuit Current    |  |                          | 3.75 | μA    | 0.0             | V <sub>IOD</sub> = 150 mV<br>All Other Pins Grounded   |
| I <sub>IL</sub>  | Input LOW Current                 |  |                          | -0.6 | mA    | Max             | V <sub>IN</sub> = 0.5V   |
| I <sub>OZH</sub> | Output Leakage Current            |  |                          | 50   | μA    | Max             | V <sub>OUT</sub> = 2.7V  |
| I <sub>OZL</sub> | Output Leakage Current            |  |                          | -50  | μA    | Max             | V <sub>OUT</sub> = 0.5V  |
| I <sub>OS</sub>  | Output Short-Circuit Current      | -60  |                          | -150 | mA    | Max             | V <sub>OUT</sub> = 0V  |
| I <sub>CCZ</sub> | Power Supply Current              |  | 78                       | 100  | mA    | Max             | V <sub>O</sub> = HIGH Z  |

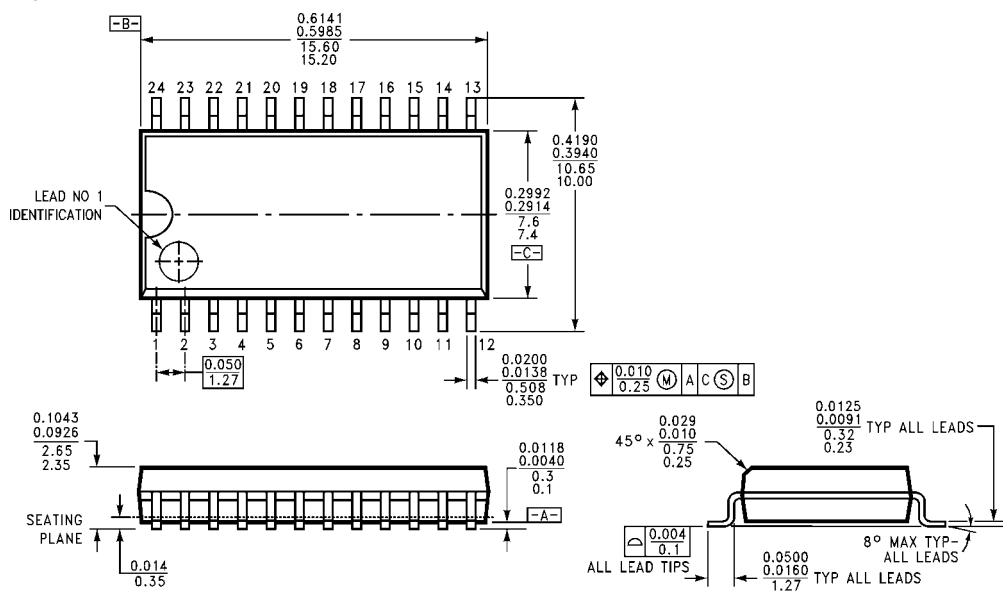
## AC Electrical Characteristics

| Symbol           | Parameter                         | T <sub>A</sub> = +25°C<br>V <sub>CC</sub> = +5.0V<br>C <sub>L</sub> = 50 pF |     |      | T <sub>A</sub> = -55°C to +125°C<br>V <sub>CC</sub> = +5.0V<br>C <sub>L</sub> = 50 pF |      | T <sub>A</sub> = 0°C to +70°C<br>V <sub>CC</sub> = +5.0V<br>C <sub>L</sub> = 50 pF |      | Units |
|------------------|-----------------------------------|---|-----|------|---|------|--|------|-------|
|                  |                                   | Min   | Typ | Max  | Min   | Max  | Min  | Max  |       |
| t <sub>MAX</sub> | Maximum Clock Frequency           | 100   | 150 |      | 60  |      | 70   |      | MHz   |
| t <sub>PLH</sub> | Propagation Delay                 | 2.0   | 6.4 | 9.5  | 2.0   | 10.5 | 2.0  | 10.5 | ns    |
| t <sub>PHL</sub> | CP to O <sub>n</sub>              | 2.0   | 6.2 | 9.5  | 2.0   | 10.5 | 2.0  | 10.5 |       |
| t <sub>PZH</sub> | Output Enable Time                | 2.0   | 5.8 | 10.5 | 2.0   | 13.0 | 2.0  | 11.5 | ns    |
| t <sub>PZL</sub> | $\overline{OE}$ to O <sub>n</sub> | 2.0   | 6.3 | 10.5 | 2.0   | 13.0 | 2.0  | 11.5 |       |
| t <sub>PHZ</sub> | Output Disable Time               | 1.5   | 3.4 | 7.0  | 1.0   | 7.5  | 1.5  | 7.5  |       |
| t <sub>PLZ</sub> | $\overline{OE}$ to O <sub>n</sub> | 1.5   | 3.5 | 7.0  | 1.0   | 7.5  | 1.5  | 7.5  |       |

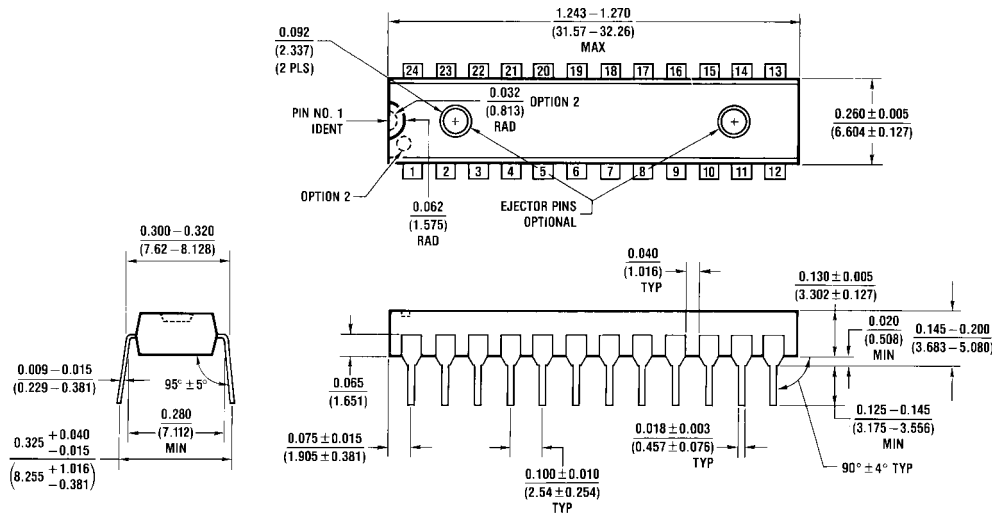
## AC Operating Requirements

| Symbol             | Parameter               | T <sub>A</sub> = +25°C<br>V <sub>CC</sub> = +5.0V |     | T <sub>A</sub> = -55°C to +125°C<br>V <sub>CC</sub> = +5.0V |     | T <sub>A</sub> = 0°C to +70°C<br>V <sub>CC</sub> = +5.0V |     | Units |
|--------------------|-------------------------|---|-----|---|-----|--|-----|-------|
|                    |                         | Min   | Max | Min   | Max | Min  | Max |       |
| t <sub>S</sub> (H) | Setup Time, HIGH or LOW | 2.5   |     | 4.0   |     | 3.0  |     | ns    |
| t <sub>S</sub> (L) | D <sub>n</sub> to CP    | 2.5   |     | 4.0   |     | 3.0  |     |       |
| t <sub>H</sub> (H) | Hold Time, HIGH or LOW  | 2.5   |     | 2.5   |     | 2.5  |     |       |
| t <sub>H</sub> (L) | D <sub>n</sub> to CP    | 2.5   |     | 2.5   |     | 2.5  |     |       |
| t <sub>W</sub> (H) | CP Pulse Width          | 5.0   |     | 6.0   |     | 6.0  |     | ns    |
| t <sub>W</sub> (L) | HIGH or LOW             | 5.0   |     | 6.0   |     | 6.0  |     |       |

# Physical Dimensions inches (millimeters) unless otherwise noted



**24-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300 Wide  
Package Number M24B**

**Physical Dimensions** inches (millimeters) unless otherwise noted (Continued)

N24C (REV F)

**24-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide  
Package Number N24C**

Fairchild does not assume any responsibility for use of any circuitry described, no circuit patent licenses are implied and Fairchild reserves the right at any time without notice to change said circuitry and specifications.

**LIFE SUPPORT POLICY**

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

[www.fairchildsemi.com](http://www.fairchildsemi.com)